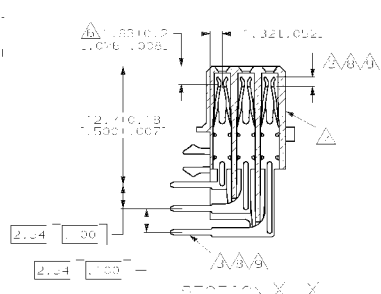
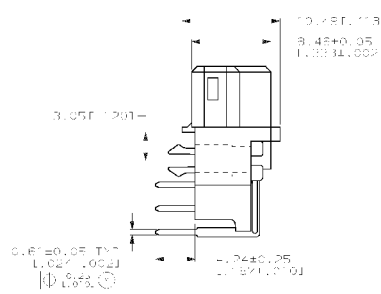
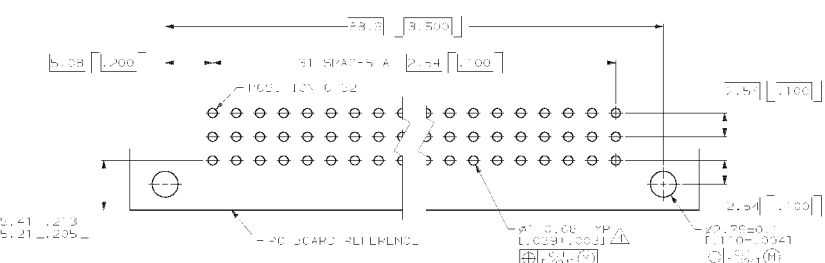
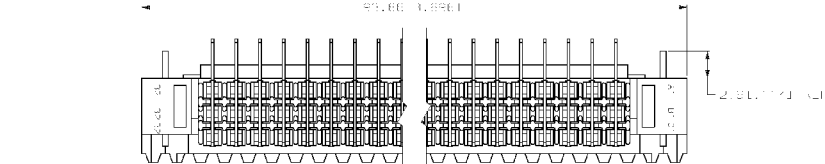
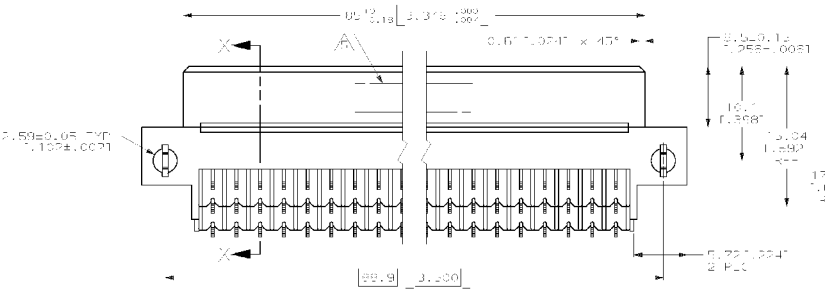
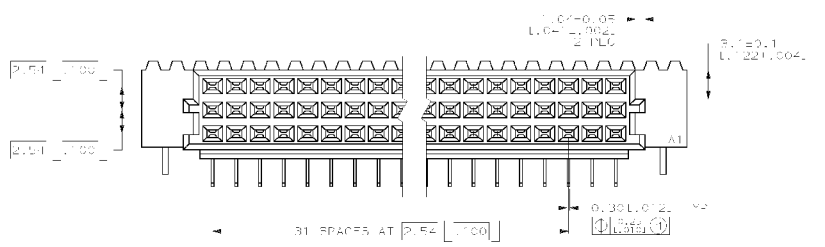


TRADE DRAWING IN THE AMERICAN SYSTEM OF DIMENSIONS IS UNLESS OTHERWISE SPECIFIED TO THE CONTRARY.
 ALL DIMENSIONS ARE UNLESS OTHERWISE SPECIFIED TO THE CONTRARY.

REV. NO.		REV. DATE		REVISIONS	BY	CHK
1	01	10	08	REVISED TO 0.01275	AS	AS



- △ POLYIMIDE MATERIAL IS ASSUMED UNLESS OTHERWISE SPECIFIED.
- △ CONTACT MATERIAL IS TUNGSTEN DISIODE.
- △ CONTACT PLATING IS 0.00075-0.000950 GOLD IN CONTACT AREA, 0.001275-0.000950 NICKEL UNDERPLATE AND COPPER FINISH ON PARTS.
- △ UNPLATED SURFACE FOR PARTIAL APPLICATION OF COILS OR INTO PC BOARD.
- △ ALL DIMENSIONS ARE DIMENSIONAL UNLESS OTHERWISE SPECIFIED.
- △ CONTACT POINT.
- △ CONTACT FINISH IS 0.00075-0.000950 IN CONTACT AREA, 0.001275-0.000950 NICKEL UNDERPLATE AND COPPER FINISH ON PARTS.
- △ CONTACT PLATING IS 0.00075-0.000950 GOLD IN CONTACT AREA, 0.001275-0.000950 NICKEL UNDERPLATE AND COPPER FINISH ON PARTS.

REV. NO.	REV. DATE	REV. DESCRIPTION	BY	CHK
01	10/08	REVISED TO 0.01275	AS	AS

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN MILLIMETERS. DIMENSIONS IN PARENTHESES ARE IN INCHES. TOLERANCES ARE: FRACTIONS DECIMALS ANGLES	OR FRACTION DECIMAL ANGLES	10/08/08 1/21/08 1/11/08 1/12/08	AMP REF. DISCREPANCY REVISIONS
PROPERTY HOUSING CONTACT	AMP D. S. FARMER PROPERTY	1/12/08	B-C PLATE ASSEMBLY - SUBCARRIER YIELDING BOARD CONNECT
FINISH CONDUCTIVE	APPLICATION SPECIFIC SPECIAL	0.00075 0.00075	650855 CUSTOMER DRAWING